TAPE Attachment Method

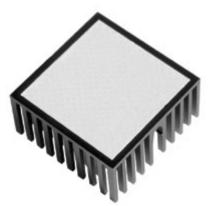
Part Number: 371824B00032G

RoHS V Compliant	hange
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BGA Surface	Таре Туре	Heat Sink Finish
Metal	<u>T405R</u>	Black Anodize

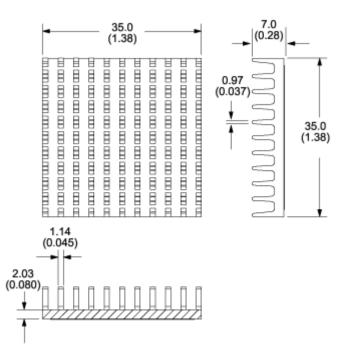
Features and Benefits

- Configurations are available for a wide range of BGA package sizes
- Tape mounted versions eliminate the need for mounting holes in the PC Board
- These Heat Sinks can be used with either plastic or metal/ceramic BGA Packages depending on tape used
- These Heat Sinks are compatible with Ther-a-grip tapes



Width	Length	Height	Fin Thickness Across Width	Fin Thickness Across Length	Base Thickness	<pre># of fins across width</pre>	<pre># of fins across length</pre>
35mm	35mm	7mm	0.97mm	1.14mm	2.03mm	11	11

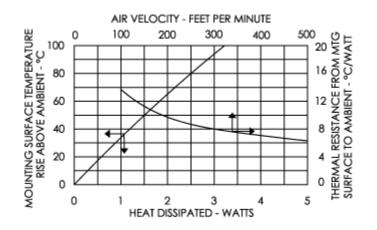
Mechanical Outline Drawing



Unless otherwise shown, tolerances are $\pm 0.38(\pm .015)$

Thermal Performance





*Natural convection thermal resistance is based on a 75 °C heat sink temperature rise.

**Forced convection thermal resistance based on an entering 1.0 m/s (200 lfm) airflow. Due to various heat dissipation paths within a BGA device, please test the heat sink in your application.